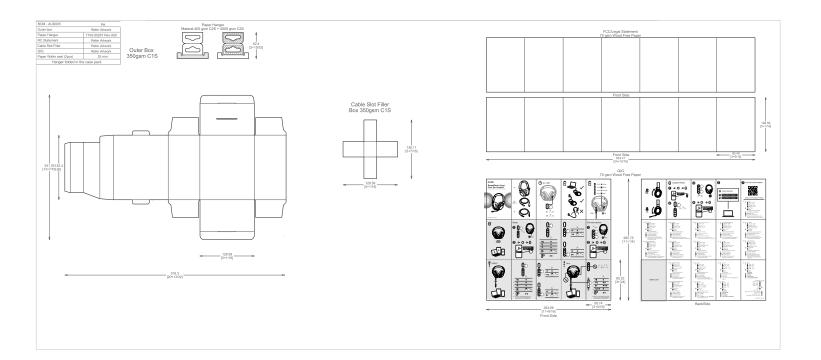
 bell	cin.

Die Line File: IDL_AUD005_PROEJECT OVER EAR HEADPHONES

Artwork File:

REV A 00

DIE LAYOUT



Business Unit: Core
Program Manager: Andrew Camba
Packaging Engineer: Matthew Duffy

Retail Outside Dimension (Including Hang Tab)

L x W x D (in): L x W x D (mm):

DIE/MATERIAL SPECS:

Material: Please refer to drawing
Blank Size (in): 65.053 x 24+3/8
Blank Size (mm): 1652.335 x 619+1/8

This dieline works for following skus (if any):

Unit: IN/MM Side Shown: PRINT SIDE Flute/Grain: horizontal

Tolerance:+/- 1/32" - 0.8mm Drawing Scale 1:1

rawing Scale 1.1

RELEASE DATE: 05/30/2023

DIELINE:

Intermediate

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DO NOT PRINT
DIE LINES, PRINTERS NOTES

PRINT SPECS:

Color Plates:

Finish:

Notes: